

Our Story

Quantum Leap Solutions is a technical sales and advisory firm with established offices in San Jose, Los Angeles, and Austin. Our expertise lies in assisting companies in the completion of their custom silicon designs through a comprehensive suite of IP, EDA, and Services offerings. Our portfolio includes highly reliable and silicon-proven IP offerings available for licensing. Whether you are working on an SOC, ASIC, RFIC, or mixed signal design, we provide compelling solutions tailored to your needs.

Since our inception in 2011, Quantum Leap Solutions has been a trusted provider of IP, design, and manufacturing services for custom IC designs throughout North America. We specialize in delivering semiconductor intellectual property (IP) and design services, offering companies silicon-proven, and low-risk solutions in targeted markets.

Our Partners

ACL Digital

ACL Digital is a global semiconductor services and solutions provider and helps its clients meet market-driven challenges. ACL Digital works closely with several integrated device manufacturers (IDMs), fabless Semiconductor Companies, Original Equipment Manufacturers, Pure Play Foundries, Engineering Design Automation (EDA) and IP vendors to accelerate their products to the market. With more than 1200 engineers and services from RTL to GDSII, ACL Digital is also a TSMC Design Center Alliance Partner, a RISC-V Center of Excellence, and an ARM Approved Design Partner.

Alphacore

The Alphacore design team has extensive experience in RF or mixed signal intellectual property (IP), including high performance ADC and DACs, specialized imaging systems, hardware-based cybersecurity solutions as well as custom design services.

EnSilica

EnSilica, a UK company founded in 2001, is a fabless ASIC supplier that designs and supplies digital & mixed signal ASICs for automotive/industrial, healthcare and communications markets. EnSilica have ASIC and design expertise in the following application areas: RF & LIDAR/Automotive, Sensing & Control, Communications & Radar, Healthcare & Medical, Satellite RFICs, Digital and DSP, ARM, RISC-V and FuSa applications.

FlexLogix

FlexLogix is a leader in embedded FPGA and AI Inferencing IP. Flex Logix provides eFPGA cores which have density and performance similar to leading FPGAs in the same process node but only use standard cells. FlexLogix EFLX eFPGA is silicon proven in 180nm, 40nm, 28/22nm, 16nm and 12nm with 6/7nm. EFLX eFPGA is in design and 5nm next.

Synopsys

Catalyzing the era of pervasive intelligence, Synopsys, Inc. (Nasdaq: SNPS) delivers trusted and comprehensive silicon to systems design solutions, from electronic design automation to silicon IP and system verification and validation. We partner closely with semiconductor and systems customers across a wide range of industries to maximize their R&D capability and productivity, powering innovation today that ignites the ingenuity of tomorrow.

ACL Digital

ACL Digital has design expertise in the following application areas:

RTL Design & Architecture

Architects - Micro Architects

RTL Front-End Design & Integration

Linting, CDC, Logical Equivalence

RTP Design, IP Design, SoC Integration

UPF Based Low Power Expertise

SoC & IP Verification

IP/SoC Verification

UNM, OVM, VMM, eRM, RVM

Assertion Based Verification

Constraint Random Verification

Power Aware Verification

Formal Verification

AMS Verification

Physical Design

Physical Design (HM, Block, SoC Level)

Scan Insertion, Synthesis and STA

Physical Verification

PPA (Power, Performance, Area Optimization))

Tools and Flow Development

Synthesis and STA

PD Implementation

Low Power Expertise

Design For Test

DFT Design - Hierarchical, Full Flat, Mixed Signal

DFT Implementation - Logic, Memory, IO

DFT Verification - ATPG, MBIST/LBIST BSCAN

Experience in Industry Standard Protocols

FPGA / Prototyping / Hardware

FPGA Based Design and V&V

Experienced Team in Safety Critical Design

Experienced Team in V&V as per DO245 DALs

Emulation - All Major Emulators

ASIC Prototyping

Board Design & Post Silicon

Memory & Analog

Circuit Design & Characterization, Tools & Foundries

Layout Design

View Verification, AMS Modeling & Verification

Memory Compiler Development

Test Chip Development

ALPHACORE Data Converters

Data Converters			Process Technologies					
MSPS	Bits	Туре	Architecture	GF55nm	TSMC 28HPC+	GF 22FDx	TSMC 16FFC	TSMC 12FFC
5,000	6	DAC	Current Steering			✓		
10,000	6	ADC	Flash			✓		
20,000	6	ADC	Flash			✓		
40,000	8	ADC	Flash			✓		
160	16	ADC	Pipeline			✓		
500	12	DAC	Current Steering	✓				
6,000	12	DAC	Current Steering			✓		
12,500	6	ADC	Time-Domain Hybrid ADC			✓		
5,000	11	ADC	Hybrid SAR			✓		
400	14	ADC	Hybrid SAR		✓			
200	14	ADC	Hybrid SAR		✓			
400	12	DAC	Current Steering		✓			
200	14	DAC	Current Steering		✓			
4,000	11	ADC	Hybrid SAR		✓			
8,000	11	ADC	Hybrid SAR		✓	✓		
6,000	11	ADC	Hybrid SAR				✓	✓
6,000	14	DAC	Current Steering				✓	✓

ALPHACORE Analog IP

	Process Technologies							
Туре	Specs	GF55nm	TSMC 28HPC+	GF 22FDx	TSMC 16FFC	TSMC 12FFC	GF130	TSMC 40 ULPe
PLL: PLL13G	Input Frequency: 40 MHz; Output Frequency: 5.5-13.5 GHz, RMS Jitter: 350fs						✓	
PLL: PLL5G150F	Input Frequency: 100 MHz, 200 MHz; Output Frequency: 5 GHz, RMS Jitter < 150fs			✓				✓
BGR							\checkmark	
200 mA Low Drop							\checkmark	
500 mA Low Drop	500 mA Low Dropout Regulator							✓
High-Speed Comp							✓	
Other analog blocks available on request:								
PLLs - please cont	PLLs - please contact QLS for more information							
Temperature Sensor								
Precision Band Ga	Precision Band Gap Reference							
Precision Sample	Precision Sample and Hold Amplifier							
Low noise input MUX								
Low-noise Amplifier								
Programmable Gain Amplifier								
Delay Locked Loops								
Pulse Width Modulator								
Samples								
Switches								
Readout Buffer								
Serial Peripheral Interface								

Other capabilities:

- CMOS Image Sensors, Readout ICs, Focal Plane Arrays, Camera Systems, Neuromorphic Imagers
- Power Management ICs for Harsh Environments, DC-DC Converters, Solar Array Interface, LDOs
- Radiation hardened solutions.

EnSilica Mixed Signal ASICS

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Automotive

H Bridge Solenoid and Motor Controllers

Advanced Radar processing

Video & imagine processing

V2X security and communication

Gas, gyro, position, pressure, force sensor interfacing

Driver monitoring / wellbeing

Battery cell monitoring

Driver monitoring systems (DMS)

ISO 26262

Communications and Radar

Signal processing for satellite and cellular communications systems

High speed interfaces CSI-2, Ethernet, CPRI, PCIe and JESD204B

RF & mmWave RF FE development

Digital beamforming and phases arrays

Base stations and Remote Radio Heads

MIMO systems

Satellite and cellular systems

Industrial

Pressure and flow sensors

Gas sensors

Chemical sensors

Movement and occupancy sensors

Motor and Solenoid controllers

Tags and RFIDs

Inductive speed and position sensors

Precision timers

GaN, Laser and LED drivers

Ultrasonic sensor drivers

Arm safety architectures

ISO 13849-1:2015 & IEC 61508-2:2010

Wearables and Healthcare

Vital signs sensor interfacing monitoring:

- Electrocardiography (ECG)
- Photoplethysmography (PPG)
- Impedance pneumography
- SpO2 measurement
- Near infra-red spectroscopy (NIRS)

- Fluorescent glucose sensing (non-invasive to body tissue)
- Body temperature sensors

Electrochemical sensor interfacing

Differential capacitive sensors

Hearing aids

Lab-on chip interfaces

Designing and integrating wireless interfaces including NFC/RFID and BLE

Satellite RFICs

Ka band suitable for GEO, LEO

17.2 to 21.2 GHz Rx

27.5 to 30.0 GHz Tx

4 Rx element paths

4 Tx element paths

Ka-band fine gain and phase control

Integrated IQ frequency conversion

Comprehensive and flexible IQ IF/BB path to data converters

Low power operation VDDRF=1.1V

Logic at 1.8V

Support for large arrays

Analog, hybrid & digital beamforming

Small size WLCSP

Digital and DSP

Systems/DSP expertise include

Modem design - BLE/DVB/DAB/WiFi

Remote Radio Heads - DDC/DUC

Advanced MIMO processing and beamforming

Advanced Radar signal processing

Cryptography

Development of efficient data-path designs

Integration of high-speed interfaces

PCIe, USB, MIPI, CSI-2, CPRI, 1/25/10Gb Ethernet, LPDDR/DDR

Processor integration

Cores - Arm, Cadence Tensilica, MIPS

AMBA - AHB/AXI/APB

Advanced Verification

Constrained random SV based verification using UVM and VIPs

Embedding system models in environment using MATLAB/SystemC

FPGA based prototyping / emulation

Post silicon validation

Bit accurate models and GPU acceleration in CUDA

Embedded software

DSP and embedded software development for Arm, TenSilica, GPUs

Linux drivers and BSP

Physical design

FlexLogix eFPGAs

FlexLogix EFLX Provides Fast Flexible Computing

Mature Solutions

- o Flexible Architecture and Sizing
- o Dynamically Reconfigurable eFPGA in useconds
- o RAD Hardened Capable

• High Density, High Performance and Low Power

- o Area and Utilization Leading Technology
- o Supported on Multiple Popular Processes
- o Optimized Functionality for Low Power

Software Tool Chain

- o Power Estimator
- o On Chip Debug

EFLX eFPGA Availability						
TSMC	Product	Logic	DSP			
40 ULP/EF*/LP*	EFLX 1K w/Power Gating	Silicon Proven	On Demand			
28 HPC/HPC+	EFLX 4K	Silicon Proven	Silicon Proven			
16 FFC/FFC+	EFLX 4K	Silicon Proven	Silicon Proven			
12 FFC/FFC+	EFLX 4K	Silicon Proven	Silicon Proven			
N7/N6	EFLX 4K	Available	Available			
NS	EFLX 4K	In Planning	In Planning			
Global Foundries						
22 FDX	EFLX 4K	In Design**	In Design**			
12 LP/LP+	EFLX 4K	Silicon Proven	Silicon Proven			
12LP LP	EFLX 4K w/Power Gating	Silicon Proven	Silicon Proven			
12LP RHBD	EFLX 4K	Silicon Proven	Silicon Proven			
Other						
Sandia 180 RHBD	EFLX 4K	Silicon Proven				
Samsung 14LPP*	EFLX 4K	Available	Available			

^{*} Available. Re-timing Required

^{**} Early IP drops available for concurrent design

Synopsys IP

Synopsys is a leading provider of high-quality, silicon-proven semiconductor IP solutions to enable efficient and reliable chip design. The broad Synopsys IP portfolio includes logic libraries, embedded memories, analog IP, wired and wireless interface IP, security IP, embedded processors and subsystems. To accelerate IP integration, software development, and silicon bring-up, Synopsys' IP Accelerated initiative provides architecture design expertise, preverified and customizable IP subsystems, hardening, signal/power integrity analysis, and IP prototyping kits. Synopsys' extensive investment in IP quality, comprehensive technical support, and robust IP development methodology enables designers to reduce integration risk and accelerate time-to-market.

Synopsys' IP offerings include:

Interface IP

Synopsys' IP portfolio helps designers efficiently integrate critical connectivity components into their SoC designs, such as USB, PCIe, DDR memory controllers, Ethernet, MIPI, and more.

ARC Processor IP

Synopsys' ARC processors provide a range of configurable and extensible CPU cores optimized for various applications, from ultra-low-power IoT devices to high-performance computing systems. These processors offer a balance between performance and power efficiency while supporting a variety of software development tools and ecosystems.

The ARC MetaWare Development Toolkit: Facilitates the development of device drivers, firmware, and software stacks for embedded processors.

ASIP Designer

The ASIP Designer tool enables the creation of Application-Specific Instruction-Set Processors (ASIPs), which are tailored to specific application workloads. This tool allows designers to optimize processor architectures for performance, power, and area based on their unique requirements.

Security IP

Synopsys' security IP portfolio includes solutions for hardware root of trust, cryptographic accelerators, secure boot, secure key storage, and more. These IP blocks help designers implement robust security features in their SoCs, safeguarding sensitive data and ensuring device integrity.

Analog IP

Synopsys' analog IP offerings cover a wide range of functions, including analog-to-digital converters (ADCs), digital-to-analog converters (DACs), voltage references, PLLs, and more. These analog IP blocks are designed to meet stringent performance and reliability requirements.

Memory IP

Synopsys provides a variety of memory IP solutions, including SRAMs, ROMs, non-volatile memory (NVM), and embedded flash. These memory IP blocks are optimized for various applications and technology nodes.

Synopsys' IP offerings are built on years of expertise and innovation, providing designers with the tools they need to accelerate their development cycles and create competitive and reliable semiconductor solutions. With a focus on quality, performance, and compatibility, Synopsys' IP portfolio helps drive the success of modern SoC designs across diverse industries.

Click here for Synopsys' full IP portfolio.

Synopsys EDA Products

Synopsys offers an advanced and comprehensive software flow tailored to meet the complex demands of semiconductor chip and SoC designers. This flow encompasses a series of interconnected tools and methodologies that collectively enable efficient design, verification, and deployment of SoCs, which integrate multiple components and functionalities onto a single chip.

Throughout the entire design flow, Synopsys' suite of software tools aims to provide a comprehensive and cohesive solution to address the various challenges of designing complex chips. The integration of these tools helps streamline the design process, improve design quality, and reduce time-to-market for innovative designs.

Below is a listing of Synopsys EDA-Software Anchor Products

Design Planning and System Architecture

The flow begins with defining the high-level architecture and design specifications for the chip. Synopsys provides tools for creating functional and performance models, as well as architectural exploration tools to optimize the design for power, performance, and area.

- **3DIC Compiler**: The Synopsys 3DIC Compiler platform is a complete, end-to-end solution for efficient, 2.5D, and 3D multi-die system integration.
- *Platform Architect*: Provides architects and system designers with SystemC[™] TLM-based tools and efficient methods for early analysis and optimization of multicore SoC architectures for performance and power.

Design Capture and Synthesis

Register Transfer Level (RTL) design involves creating the digital logic description of the chip. Synopsys tools aid in RTL coding, verification, and synthesis, converting the design into gates and optimizing it for power, performance, and area.

- Design Compiler: Handles RTL coding, synthesis, and optimization for power, performance, and area.
- Fusion Compiler: Fusion Compiler features a unique RTL-to-GDSII architecture that enables customers to reimagine what is possible from their designs and take the fast path to achieving maximum differentiation.
- **Custom Compiler**: As the heart of the Synopsys Custom Design Family, Custom Compiler provides design entry, simulation management and analysis, and custom layout editing features.

Verification

Ensuring the correctness of the design is paramount. Synopsys' verification tools encompass simulation, emulation, and formal verification techniques. They help identify and resolve functional errors and ensure the design behaves as expected.

- VCS (Verilog Compiler Simulator): A high-performance simulation tool for verifying the correctness of the design.
- *VC SpyGlass*: Synopsys VC SpyGlass integrates advanced algorithms and analysis techniques that provides designers detailed information and insights about their design much earlier in the RTL phase.
- **Verdi**: Enables comprehensive debug for all design and verification flows. It includes powerful technology that helps you comprehend complex and unfamiliar design behavior, automate difficult and tedious debug processes and unify diverse and complicated design environments.
- **VSO.ai:** Synopsys VSO.ai[™] (Verification Space Optimization) delivers the industry's first Al-driven verification solution to help verification teams achieve coverage closure faster and with higher quality.
- PrimeSim: PrimeSim[™] SPICE is a high-performance SPICE circuit simulator for analog, RF, and mixed-signal
 applications.

Implementation

This stage involves translating the logical design into a physical layout. Synopsys tools assist in floorplanning, placement, routing, and chip assembly, optimizing for manufacturability and performance.

- **Fusion Compiler**: Fusion Compiler features a unique RTL-to-GDSII architecture that enables customers to reimagine what is possible from their designs and take the fast path to achieving maximum differentiation.
- **DSO.ai**: DSO.ai searches for optimization targets in very large solution spaces of chip design, utilizing reinforcement learning to enhance power, performance, and area.
- **Custom Compiler**: As the heart of the Synopsys Custom Design Family, Custom Compiler provides design entry, simulation management and analysis, and custom layout editing features.

Analog/Mixed Signal Design

- Custom Compiler: Tool for custom layout design of analog and mixed-signal circuits.
- PrimeSim HSPICE: PrimeSim HSPICE is the industry's 'gold standard' for accurate circuit simulation and
 offers foundries-certified MOS device models with state-of-the-art simulation and analysis algorithms.

Signoff

Synopsys' design analysis and signoff solution includes a broad portfolio of products for static timing analysis, advanced signal integrity, power and power integrity, parasitic extraction, ECO closure, transistor-level analysis and library characterization.

- **PrimeTime**: Enables power analysis and optimization.
- **PrimePower**: Power analysis tool for estimating power consumption and optimizing power distribution networks
- StarRC: The StarRC[™] solution is the EDA industry's gold standard for parasitic extraction.
- IC Validator: Synopsys IC Validator[™] physical verification high-performance signoff solution improves
 productivity for customers at all process nodes, from mature to advanced.

Silicon Test & Lifecycle Management

Synopsys integrated Silicon Lifecycle Management (SLM) family of products improves silicon health and operational metrics at every phase of the device lifecycle. Synopsys SLM family of products is built on a foundation of enriched in-chip observability, analytics and integrated automation. Monitors enable deep insights from silicon to system. Meaningful data is gathered at every opportunity for continuous analysis and actionable feedback.

- **TestMAX**: The Synopsys TestMAX[™] family of products offers innovative, next-level test and diagnosis capabilities for all digital, memory and analog portions of a semiconductor device.
- **DFT/ATPG**: ATPG is Synopsys' state-of-the-art pattern generation solution that enables design teams to meet their test quality and cost goals with unprecedented speed.
- **TSO.ai**: TSO.ai automatically searches for an optimal solution in a large test search space to minimize pattern count and ATPG turn-around time reducing test costs dramatically.
- PVT Sensors: As the name implies, PVT sensors represent embedded analog IP blocks that are typically
 integrated into SoCs with the goal of sensing the process variability and operating environment of the chip.
 These devices exploit the fact that certain measurable characteristics of a semiconductor device change
 depending on levels of activity, due to variable software operation or CPU loading, and also from
 environmental conditions.
- Path-Margin IP: Path selection logic, RTL configuration and generation, connecting to functional and/or test
 paths, synthesis, implementation, timing validation and path qualification are the key functions addressed by
 the EDA automation provided.

Prototyping and Emulation

Synopsys tools enable the creation of FPGA-based prototypes and hardware emulators for early software development and system validation.

- **HAPS Prototyping Solution**: Enables FPGA-based prototypes for software development and system validation.
- Zebu Server: Provides hardware emulation capabilities.

TCAD, OPC, Smart Manufacturing

The smart manufacturing solutions from Synopsys are built upon Synopsys' extensive expertise in IC design, mask synthesis, process modeling, on-chip test and monitoring techniques and cloud-based data analytics.

- **Proteus OPC**: achieve exceptional precision, efficiency and speed in proximity correction, model building for correction, and analyzing proximity effects on corrected and uncorrected IC layout patterns, revolutionizing your chip fabrication process.
- **Sentaurus**: Sentaurus Process is an advanced 1D, 2D and 3D process simulator for developing and optimizing silicon semiconductor process technologies.
- **TCAD**: Synopsys TCAD offers a comprehensive suite of products that includes industry-leading process and device simulation tools, as well as a powerful graphical user interface (GUI) driven simulation environment for managing simulation tasks and analyzing simulation results.
- **BISTel Yield Management**: BISTel solutions collect, manage, and analyze data, monitor the health of equipment, optimize process flows, identify the root cause of failures rapidly, and predict outcomes to mitigate manufacturing risks.